

TECHNICAL EVALUATION REPORT (As Per Rule 35 of PP Rules-2004)

1. Name of Procuring Agency:	National Bank of Pakistan	
2. Method of Procurement:	36 (b) - Single Stage Two Envelope Procedure,2004	
3. Title of Procurement:	Procurement of One Million UPI EMV Cards	
4. Tender Inquiry No.:	NT-09/28/2023-3	
5. PPRA Ref. No. TSE:	TS521729E	
6. Date & Time of Bid Submission:	18 th October 2023 at 3:00 pm	
7. Date & Time of Bid Opening:	18 th October 2023 at 3:30 pm	
8. Number of Bids Received:	One (01)	
9. Criteria for Bid Evaluation:	Mention in standard Bidding document.	
10. Details of Bid(s) Evaluation:	As follows	

Name of Bidder	Technical Marks (If Applicable)	As Per Rule 35 of PP Rules-2004
M/s. SecurPrint Pvt Ltd	Technically Qualified	Proposal qualified as per technical requirement of SBD.

(Divisional Head) Procurement Division Logistics, Communications & Marketing Group Head Office, NBP, Karachi.

Technical Compliance

Bidder's shall quote the solution that comply with the required minimum Technical Specifications along-with its implementation, support and warranty, as any alternate or additional solution will not be considered for evaluation and its bid will be considered as Technically <u>Non-Responsive</u>.

- 1. For all bidder's requirements against which Bidder is responding "Y", all bidders are required to provide Documentation with proper reference (Section No/ Page No) in the proposal against all requirements. It is mandatory to provide proper reference of document.
- 2. Bids will be considered non-Responsive if bidder's response with 'N' / 'No' or incomplete response against any of the below criteria.
- 3. NBP will only raise clarification queries against requirements where reference is provided, and further clarification is required. Incase no reference is provided, and documents are not available in the submitted proposal, NBP may not raise any clarification query and response will be considered as NIL, which may lead to disqualification.
- 4. All bidders are required to affix their company's stamp/signature on each page of the submitted Technical Specifications.